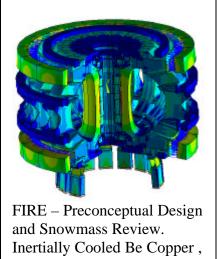


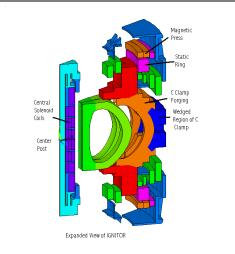
## BNL Pulsed Magnet Magnet System Cooldown and Structural Analyses February-9 2002

Peter H. Titus MIT Plasma Science and Fusion Center, Cambridge MA (617) 253 1344, <u>titus@psfc.mit.edu</u>, http://www.psfc.mit.edu/people/titus

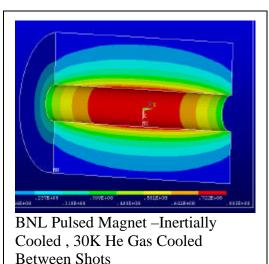
The Collaboration is Useful with Other PSFC Projects:



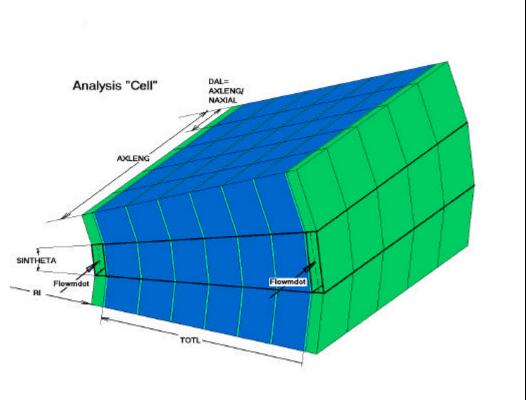
Inertially Cooled Be Copper, LN2 Cooling Between Shots, with a Helium Purge to Limit Activation



IGNITOR – Snowmass Review. -Inertially Cooled Copper, 30K He Gas Cooled Between Shots







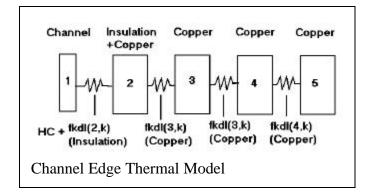
#### 2.1.3 Convective Heat Transfer

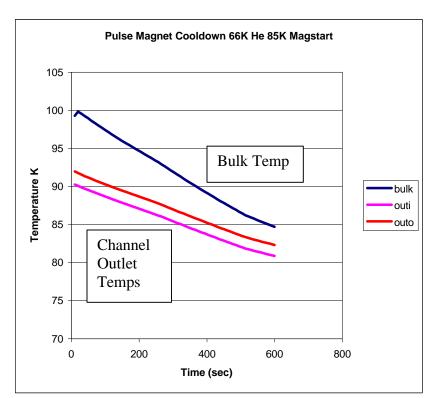
It is important to estimate how much heat the supdamentation (T > 77 K) could absorb before exiting the cooling channel. The convective heat transfer coefficient, h, could be obtained from<sup>9</sup>

$$h = \frac{KNu}{D_{e}} = \frac{0.023Re^{0.8}Pr^{0.4}K}{D_{e}} .$$
 (14)

This coefficient is about  $21 \times 10^{-3}$  W/cm<sup>2</sup> K at a vapor temperature of 200 K, vapor velocity of 40 m/s, and hydraulic diameter of 2 cm. It drops to  $17 \times 10^{-3}$  W/cm<sup>2</sup> K at a vapor temperature of 100 K, keeping the mass flow rate constant. It is interesting to note that the heat transfer coefficient for film boiling at 200 K from Fig. 4 is about  $12 \times 10^{-3}$  W/cm<sup>2</sup> K, which partially justifies the third assumption in Sect. 2.1.

excerpt from: ORNL/FEDC-85-10 Dist Category UC20 c,dated October 1986



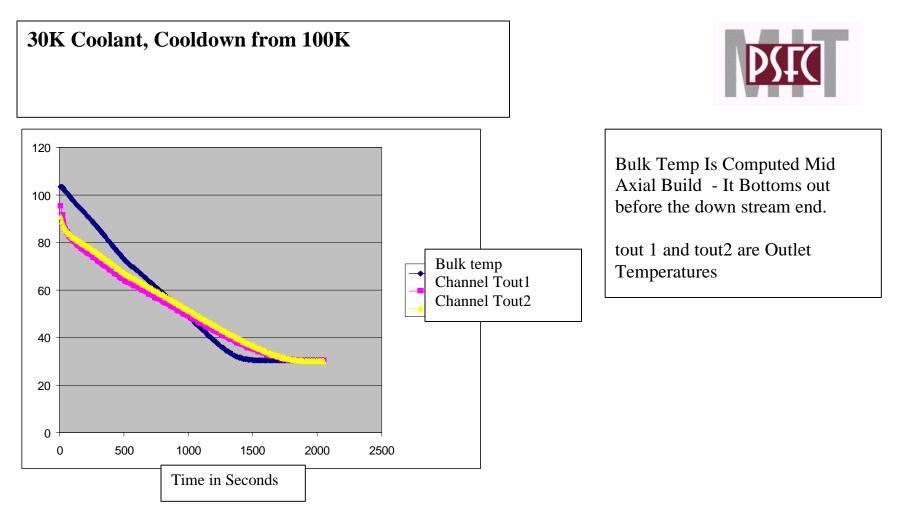


66K inlet temperature, Time Step = .0001 sec -100 K after Pulse Temp, The bulk temp is computed at a mid -axial slice. Time to 85K is about 600 sec or 10 min. Exclusive of time to flatten temp distribution.

"Cell " Temperature profiles. Time is diagonally to the right. "Bunched" lines represent the axial temperature distribution.

Present Operational Scenarios:

Case #	Peak Field	T after pulse	T coolant	Start Bulk Temp	Guestimated Time
1	5T	90K	66K	84K	~200 sec
2	10T	96K	66K	74K	~800 sec
3	15T	78K	22K	30K	~1500 sec



Analyses to date: Time to	o target bulk temp	o. <sup>1</sup> / <sub>2</sub> inch Copper	Conductor, 100K,

	T after	Т	Cond	Time to	Time to
	pulse	coolant	Layers	85K sec	30K sec
Equiv 5 Kapton .001in wrap	100K	66K	6 layers	600	
Equiv 5 Kapton .001in wrap	100K	66K	8 layers	>850	
Equiv 3 Kapton .001in wrap	100K	66K	8 layers	450	
Equiv 5 kapton .0001in wrap	100K	30K	6 Layers		2000





## Coil Stress Estimate

R		Z	dr		Dz		
.20425	5	0	.2415		.97		
Stresse	es foi	this of	coil, MI	Pa:			
Field	Sm	eared	Ноор		Smeared VM		
10T	80.3				82.6		
15T	180.7			186			
Stresse	es foi	this of	coil with	h .8:	5 packing fraction	n, MPa:	
Field	Sm	eared	Ноор	Sn	neared VM		
10T	94.:	5		97	7.2		
15T	212	8		21	8.8		

Interpolated values:, Work hardened copper-, OFHC c10100 60% red

.237E+08	.399E+08 .561E+08 .722E+08 318E+08 .480E+08 .641E+08 .803E+08

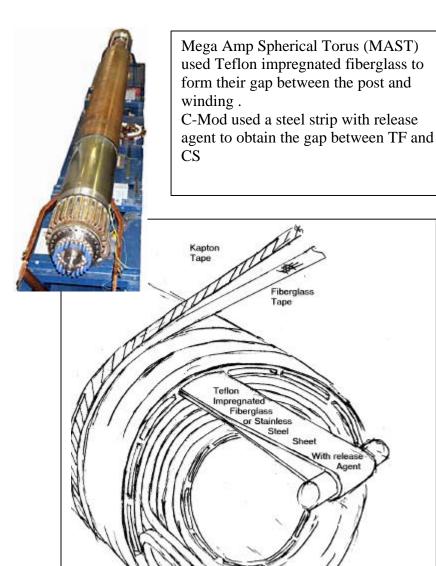
temp deg k	77	90	100	125	150	200	250	275	292
yield	374	369.	365.	356.	347.	328.	317.	312.	308.
ultimate	476.	466.	458.	439.	420.	383.	365.	356.	
									350.

Stress Will be Lower for the 14,5T .8m OD

#### **Engineering Tasks**



- Identify Voltages for All Operating Scenarios Choose Insulation Systems. Determine where Kapton is used.
- Stress Analysis, Assess Radial load on Channel Ligaments, Necessity for Outer Ring, Operation with Inner Modules Energized, No Current in Outer Module
- Confirm Cooldown and Pressure Drop Calculations
- Thermal Contraction/Shock of Channel Avoid Separation and Loss of Conduction
- 10 atm He Can Design
- Mandrel and Flow Plenums Design
- Cryostat Design. Is this a Vacuum Cryostat with LN2 Shield, or a Gaseous N2?
- Break-outs and Leads Penetration design Support in radial Field
- Eddy Currents in He Can.
- Cryogenic Electrical Breaks
- Design Supports, Break-outs, He can and Cryostat to Allow Phased Construction



Sheet

With release

Agent

Layer Insulation and Forming the Channels



- Kapton is the limiting element in the thermal conduction through the coil.
- Kapton was expected to be wound around the conductor. This produced the equivalent of 5 mils of Kapton between layers.
- To improve conduction, Kapton is used only between the layers. Turn to turn voltage is lower than layer to layer. The turn to turn voltage is less than the rule of thumb for He breakdown voltage (1 volt/mil at 1 atmosphere) for the insulation thickness proposed.
- The layer to layer voltage exceeds this however, and would need the Kapton if there was an imperfection in the epoxy/glass insulation. Half lapps of kapton and fiberglass, similar to the CS model coil will retain some structural integrity.
- Once a layer of conductor is wound, a layer of Kapton/glass would be wound on the completed layer of conductor. This produces the equivalent of 3 mils of Kapton rather than 5 if the conductor is wrapped individually. only Every 8th layer some sort of preformed channel array would be layed on, then wrapped with glass/Kapton to hold it in place.



	gen cryostat.	
	Cost(\$1000) Inner Two Modules	Cost(\$1000) Three Modules
Materials - Dies (2) - Conductor - Kapton - Fiberglass	4 30 14 4	4 60 28 8
Tooling	10	10
**Labor	76	152
He Pressure Can, Mandrel and Fiberglass Cryostat	30	30
Total	168	292
* Conductor estimate: 1300 turns, total length of 833 meter ** Labor estimate: 1300 turns total, average of 20 turns	8	ter for estimate)
average of 65 days, at 5 days per we	01	Original Cost B
or 520 hours, at \$60/hour equals to	-	R z
estimating one week of setup time S		.20425 0

# Table 1. Cost estimate for industry fabrication of pulsed copper coiland liquid nitrogen cryostat.

Original Cost Basis							
R	Z	dr	Dz				
.20425	0	.2415	.97				

Helium Cooling Not Costed, but Plenum and Channels are similar.

Plus two weeks of impregnation \$4.8 K Adds up to \$38.4K rounded off to \$38K

**Contingency not included: recommend 10% or \$9K** 

Table 2. Budgetary estimate for desi	ign, fabrication supervis	sion, and testing and
installation of pulsed coppe	er magnets January 2, 200	2 - October 31, 2002
	Porson Months	Funds

PhasePhasePhasePhasePhasePhaseSummaryOneTwoThreeOneTwoThreeENGRFABTESTMagnetFabr.AcceptanceImage: Comparison of the second sec		One				Phase	Phase	Summarv
ENGR FAB TEST			Two	Three	0			
					One	Two	Three	, i i i i i i i i i i i i i i i i i i i
Magnet Fabr. Acceptance					ENGR	FAB	TEST	
		Magnet	Fabr.	Acceptance				
Design Supervision Testing		0	Supervision					
<b>ENGINEERING PERSONNEL</b> 3.2 2.54 1.7 \$48,500 \$37,000 \$22,000 \$107,500	GINEERING PERSONNEL	3.2	2.54	1.7	\$48,500	\$37,000	\$22,000	\$107,500
OTHER PERSONNEL	HER PERSONNEL							
Designers 2.9 0 0 \$26,000 \$0 \$26,000	Designers	2.9	0	0	\$26,000	\$0	\$0	\$26,000
Technicians 0 0 2 \$0 \$18,000 \$18,000	Technicians	0	0	2	\$0	\$0	\$18,000	\$18,000
Other(Allocated Admin. Support) \$5,000 \$4,000 \$4,000 \$13,000	Other(Allocated Admin. Sı	ipport)			\$5,000	\$4,000	\$4,000	\$13,000
TOTAL OTHER PERSONNEL \$31,000 \$4,000 \$22,000 \$57,000	TOTAL OTHER PERSONN	EL			\$31,000	\$4,000	\$22,000	\$57,000
TOTAL SALARIES, WAGES & FRINGE BENE FITS       \$79,500       \$41,000       \$164,500	TOTAL SALARIES, WAG	ES & FRINGE BI	ENE FITS		\$79,500	\$41,000	\$44,000	\$164,500
TRAVEL 1. Domestic         \$2,400         \$13,000         \$5,200         \$20,600	AVEL 1. Domestic				\$2,400	\$13,000	\$5,200	\$20,600
OTHER COSTS	THER COSTS							
1. Materials and Supplies \$800 \$300 \$750 \$1,850	Materials and Supplies				\$800	\$300	\$750	\$1,850
								-
	1 0						-	
					\$0	\$0	\$1,800	\$1,800
					\$300	\$250	\$250	
TOTAL OTHER DIRECT COSTS         \$3,100         \$10,800         \$14,900	TAL OTHER DIRECT COSTS				\$3,100	\$1,000	\$10,800	\$14,900
TOTAL COSTS of PROJECT         \$85,000         \$60,000         \$200,000	TAL COSTS of PROJECT				\$85,000	\$55,000	\$60,000	\$200,000

Notes:

1) All costs are fully loaded

2) Phase I duration: 4 Months, Jan. 2, 2002 - April 30, 2002
3) Phase II duration: May 1, 2002 - August 31, 2002
4) Phase III duration: September 1, 2002 - October 31, 2002